



**ALPHA & OMEGA**  
SEMICONDUCTOR, LTD



**AO8803**

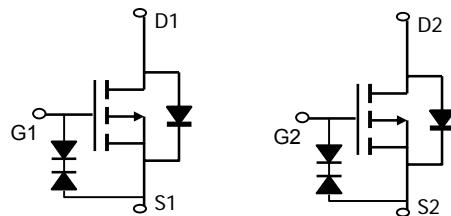
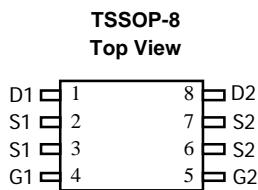
**Dual P-Channel Enhancement Mode Field Effect Transistor**

### General Description

The AO8803 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 1.8V. This device is suitable for use as a load switch or in PWM applications. It is ESD protected. Standard Product AO8803 is Pb-free (meets ROHS & Sony 259 specifications). AO8803L is a Green Product ordering option. AO8803 and AO8803L are electrically identical.

### Features

$V_{DS}$  (V) = -12V  
 $I_D$  = -7 A ( $V_{GS}$  = -4.5V)  
 $R_{DS(ON)} < 18m\Omega$  ( $V_{GS}$  = -4.5V)  
 $R_{DS(ON)} < 22m\Omega$  ( $V_{GS}$  = -2.5V)  
 $R_{DS(ON)} < 29m\Omega$  ( $V_{GS}$  = -1.8V)  
 ESD Rating: 4KV HBM



### Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

Parameter	Symbol	Maximum		Units
Drain-Source Voltage	$V_{DS}$	-12		V
Gate-Source Voltage	$V_{GS}$	$\pm 8$		V
Continuous Drain Current <sup>A</sup>	$T_A=25^\circ C$	-7		A
Current <sup>A</sup>		-5.8		
Pulsed Drain Current <sup>B</sup>	$I_{DM}$	-20		
Power Dissipation <sup>A</sup>	$T_A=25^\circ C$	1.4		W
		0.9		
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 150		°C

### Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient <sup>A</sup>	$t \leq 10s$	73	90	°C/W
Maximum Junction-to-Ambient <sup>A</sup>		96	125	°C/W
Maximum Junction-to-Lead <sup>C</sup>	$R_{\theta JL}$	63	75	°C/W

**Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>STATIC PARAMETERS</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$I_D=-250\mu\text{A}, V_{GS}=0\text{V}$	-12			V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{DS}=-9.6\text{V}, V_{GS}=0\text{V}$ $T_J=55^\circ\text{C}$			-1 -5	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm 4.5\text{V}$ $V_{DS}=0\text{V}, V_{GS}=\pm 8\text{V}$			$\pm 1$ $\pm 10$	$\mu\text{A}$
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu\text{A}$	-0.3	-0.55	-1	
$I_{D(\text{ON})}$	On state drain current	$V_{GS}=-4.5\text{V}, V_{DS}=-5\text{V}$	-20			A
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{GS}=-4.5\text{V}, I_D=-7\text{A}$ $T_J=125^\circ\text{C}$		15 19	18 23	$\text{m}\Omega$
		$V_{GS}=-2.5\text{V}, I_D=-6\text{A}$			18	$\text{m}\Omega$
		$V_{GS}=-1.8\text{V}, I_D=-5\text{A}$			22	$\text{m}\Omega$
		$V_{GS}=-1.5\text{V}, I_D=-1\text{A}$			28	$\text{m}\Omega$
$g_{\text{FS}}$	Forward Transconductance	$V_{DS}=-5\text{V}, I_D=-7\text{A}$		34		S
$V_{\text{SD}}$	Diode Forward Voltage	$I_S=-1\text{A}, V_{GS}=0\text{V}$		-0.78	-1	V
$I_s$	Maximum Body-Diode Continuous Current				-2.5	A
<b>DYNAMIC PARAMETERS</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=-6\text{V}, f=1\text{MHz}$		3960	4750	pF
$C_{\text{oss}}$	Output Capacitance			910		pF
$C_{\text{rss}}$	Reverse Transfer Capacitance			757		pF
$R_g$	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$		6.9	8.5	$\Omega$
<b>SWITCHING PARAMETERS</b>						
$Q_g$	Total Gate Charge	$V_{GS}=-4.5\text{V}, V_{DS}=-6\text{V}, I_D=-7\text{A}$		36.6	44	nC
$Q_{gs}$	Gate Source Charge			3.4		nC
$Q_{gd}$	Gate Drain Charge			10		nC
$t_{D(\text{on})}$	Turn-On Delay Time	$V_{GS}=-4.5\text{V}, V_{DS}=-6\text{V}, R_L=0.86\Omega, R_{\text{GEN}}=3\Omega$		15		ns
$t_r$	Turn-On Rise Time			43		ns
$t_{D(\text{off})}$	Turn-Off Delay Time			158		ns
$t_f$	Turn-Off Fall Time			95		ns
$t_{rr}$	Body Diode Reverse Recovery Time		$I_F=-7\text{A}, dI/dt=100\text{A}/\mu\text{s}$	49	60	ns
$Q_{rr}$	Body Diode Reverse Recovery Charge	$I_F=-7\text{A}, dI/dt=100\text{A}/\mu\text{s}$		19.4		nC

A: The value of  $R_{\text{0JA}}$  is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The value in any given application depends on the user's specific board design. The current rating is based on the  $t \leq 10\text{s}$  thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

C. The  $R_{\text{0JA}}$  is the sum of the thermal impedance from junction to lead  $R_{\text{0JL}}$  and lead to ambient.

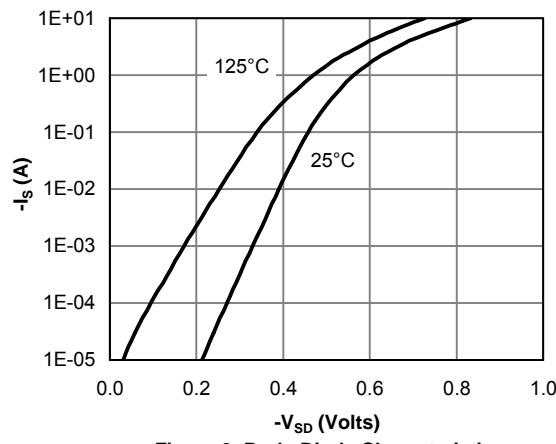
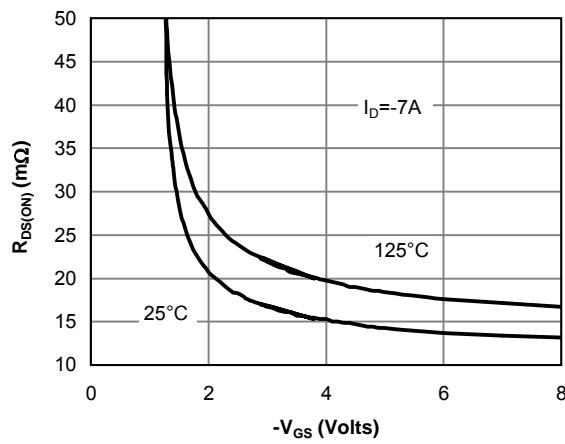
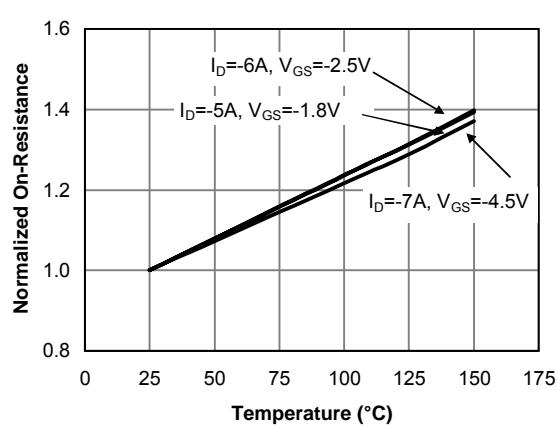
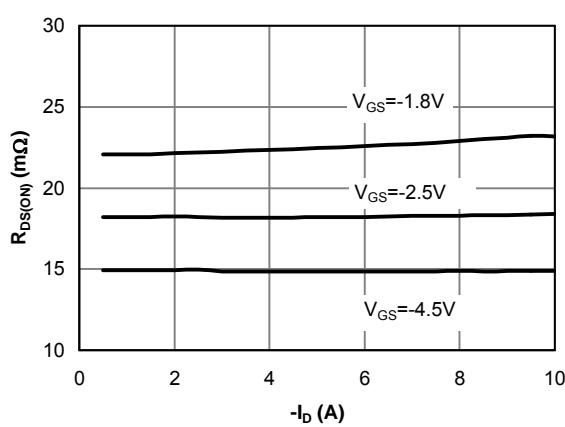
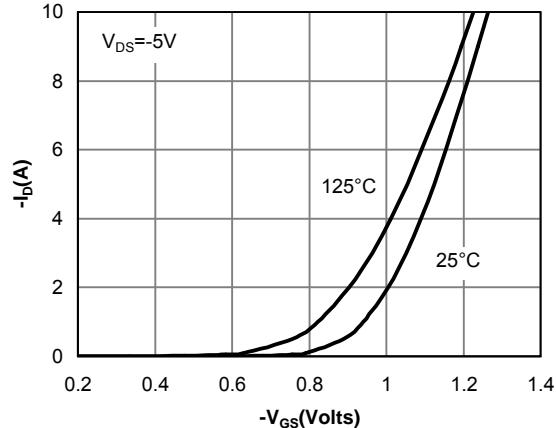
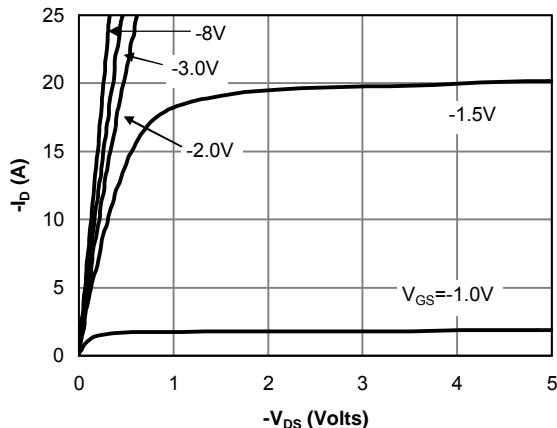
D. The static characteristics in Figures 1 to 6,12,14 are obtained using 80  $\mu\text{s}$  pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The SOA curve provides a single pulse rating.

Rev 4 : September 2005

THIS PRODUCT HAS BEEN DESIGNED AND QUALIFIED FOR THE CONSUMER MARKET. APPLICATIONS OR USES AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS ARE NOT AUTHORIZED. AOS DOES NOT ASSUME ANY LIABILITY ARISING OUT OF SUCH APPLICATIONS OR USES OF ITS PRODUCTS. AOS RESERVES THE RIGHT TO IMPROVE PRODUCT DESIGN, FUNCTIONS AND RELIABILITY WITHOUT NOTICE.

## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

